

09-12-2005



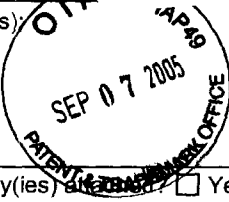
U.S. Department of Commerce
Patent and Trademark Office
Attorney Docket No. 08372.0020
Attorney Customer Number: 22,852

To the Honorable Commissioner of Patent
Please record the attached original document

103078049

TN. BOX ASSIGNMENTS RECORDATION
SERVICES

1. Name of conveying party(ies):
1) Katsuya OKUMURA
2) Toshiyuki MATSUMOTO
3) Naaki IKEUCHI
4) Masami YAKABE



2. Name and address of receiving party(ies):
Name: 1) OCTEC INC.
2) TOKYO ELECTRON LIMITED

Additional name(s) of conveying party(ies) Yes No

Internal Address: 1) 1-22-1-103, Wakaba, Shinjuku,
Tokyo 160-0011 Japan
2) 3-6, Akasaka 5-chome, Minato-ku,
Tokyo 107-8481 Japan

3. Nature of conveyance:

Street Address:

Assignment Merger

City:

Security Agreement Change of Name

State: Zip Code:

Other:

Additional name(s) & Address(es) attached?

Execution Date: 1) August 1, 2005
2) August 8, 2005
3) August 8, 2005
4) August 8, 2005

Yes No

4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application:

A. Patent Application Number(s):
11/149,176

B. Patent Number(s):

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Mr. Ernest F. Chapman

6. Total number of applications and registrations involved:
1

7. Total fee (37 CFR 3.41): \$40

Enclosed (Please charge deficiency to deposit account)
 Authorized to be charged to deposit account

Internal Address: FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER, L.L.P.

Street Address: 901 New York Avenue, NW

City: Washington, D.C.

State: Zip: 20001-4413

8. Deposit Account No.: 06-0916

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

David W. Hill
Reg. No. 28,220

Ernest F. Chapman
for David W. Hill
Signature ERNEST F. CHAPMAN

September 7, 2005
Date

Total number of pages including cover sheet, attachments and documents: 5

UNITED STATES PATENT RIGHTS, OR
UNITED STATES PLUS ALL FOREIGN PATENT RIGHTS

ASSIGNMENT

Application No. 11/149,176

Filed June 10, 2005

Insert Name(s)
of Inventor(s)

→ WHEREAS, Katsuya OKUMURA, Toshiyuki MATSUMOTO,
Naoki IKEUCHI, and Masami YAKABE

Insert Title
of Invention

(hereinafter designated as the undersigned) has (have) invented certain new and useful improvements in _____
→ Device for Inspecting Micro Structure, Method for Inspecting
Micro Structure and Program for Inspecting Micro Structure

for which an application for Letters Patent of the United States of America has been executed by the undersigned (except in the case of a provisional application).

Insert Date of
Signing of
Application

→ on August 1, 2005 and August 8, 2005 ; and

Insert Name
of Assignee

→ WHEREAS, _____
(1) Octec Inc. and (2) TOKYO ELECTRON LIMITED

Insert Address
of Assignee

→ of _____
(1) 1-22-1-103, Wakaba, Shinjuku-ku, Tokyo 160-0011 Japan and
(2) 3-6, Akasaka 5-chome, Minato-ku, Tokyo 107-8481 Japan

its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America and

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IF APPROPRIATE

→ in any and all foreign countries.

NOW, THEREFORE, in consideration of the sum of Ten Dollars (\$10.00) to the undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these presents does sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America, its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America, its territories, dependencies and possessions, and if the box above is designated, in any and all foreign countries;

and to any and all divisions, reissues, continuations, conversions and extensions thereof for the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or Letters Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) the request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patents resulting from said application or any continuing, divisional, conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Finnegan, Henderson, Farabow, Garrett & Dunner, L.L.P. the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date August 1, 2005 , Name of Inventor Katsuya Okumura
Katsuya OKUMURA

Date _____ , Name of Inventor _____
Toshiyuki MATSUMOTO

Date _____ , Name of Inventor _____
Naoki IKEUCHI

Date _____ , Name of Inventor _____
Masami YAKABE

Date _____ , Name of Inventor _____

Date _____ , Name of Inventor _____

Date _____ , Name of Inventor _____

Date _____ , Name of Inventor _____

Date _____ , Name of Inventor _____

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UNITED STATES PLUS ALL FOREIGN PATENT RIGHTS

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➔ Device for Inspecting Micro Structure, Method for Inspecting
Micro Structure and Program for Inspecting Micro Structure

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Insert Date of
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➔ on August 1, 2005 and August 8, 2005 ; and

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of Assignee

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(1) Octec Inc. and (2) TOKYO ELECTRON LIMITED

Insert Address
of Assignee

➔ of _____
(1) 1-22-1-103, Wakaba, Shinjuku-ku, Tokyo 160-0011 Japan and
(2) 3-6, Akasaka 5-chome, Minato-ku, Tokyo 107-8481 Japan

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its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America and
➔ in any and all foreign countries.

NOW, THEREFORE, in consideration of the sum of Ten Dollars (\$10.00) to the undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these presents does sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America, its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America, its territories, dependencies and possessions, and if the box above is designated, in any and all foreign countries;

and to any and all divisions, reissues, continuations, conversions and extensions thereof for the full term or terms for which the same may be granted.

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In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date _____, Name of Inventor _____
Katsuya OKUMURA

Date August 8, 2005, Name of Inventor Toshiyuki MATSUMOTO
Toshiyuki MATSUMOTO

Date August 8, 2005, Name of Inventor Naoki IKEUCHI
Naoki IKEUCHI

Date August 8, 2005, Name of Inventor Masami YAKABE
Masami YAKABE

Date _____, Name of Inventor _____

Date _____, Name of Inventor _____

Date _____, Name of Inventor _____

Date _____, Name of Inventor _____

Date _____, Name of Inventor _____